

HSM276S

Silicon Schottky Barrier Diode for Balanced Mixer

REJ03G0610-0700
(Previous: ADE-208-039F)
Rev.7.00
Apr 26, 2005

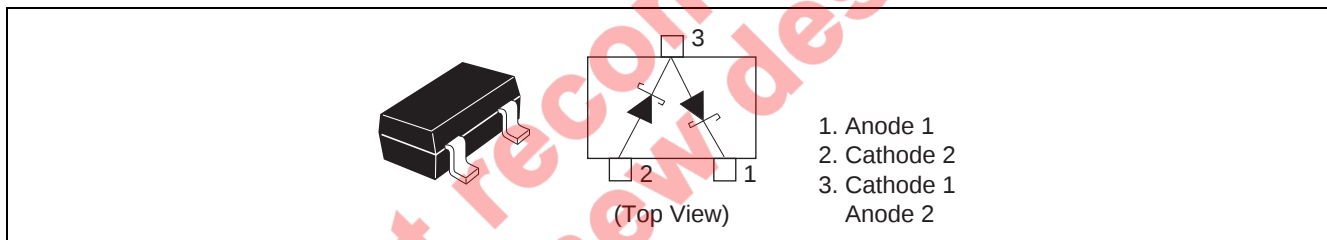
Features

- High forward current, Low capacitance.
- HSM276S which is interconnected in series configuration is designed for balanced mixer use.
- MPAK package is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Name	Package Code (Previous Code)
HSM276S	C2	MPAK	PLSP0003ZC-A (MPAK)

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	3	V
Average rectified current	I_O^{*1}	30	mA
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 to +125	°C

Note: 1. Per one device

Electrical Characteristics ^{*1}

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse voltage	V_R	3.0	—	—	V	$I_R = 1 \text{ mA}$
Reverse current	I_R	—	—	50	μA	$V_R = 0.5 \text{ V}$
Forward current	I_F	35	—	—	mA	$V_F = 0.5 \text{ V}$
Capacitance	C	—	—	0.90	pF	$V_R = 0.5 \text{ V}, f = 1 \text{ MHz}$
Capacitance deviation	ΔC	—	—	0.10	pF	$V_R = 0.5 \text{ V}, f = 1 \text{ MHz}$
ESD-Capability ^{*2}	—	30	—	—	V	$C = 200 \text{ pF}, R = 0 \Omega$, Both forward and reverse direction 1 pulse.

Notes: 1. Per one device

2. Failure criterion ; $I_R \geq 100 \mu\text{A}$ at $V_R = 0.5 \text{ V}$

Main Characteristic

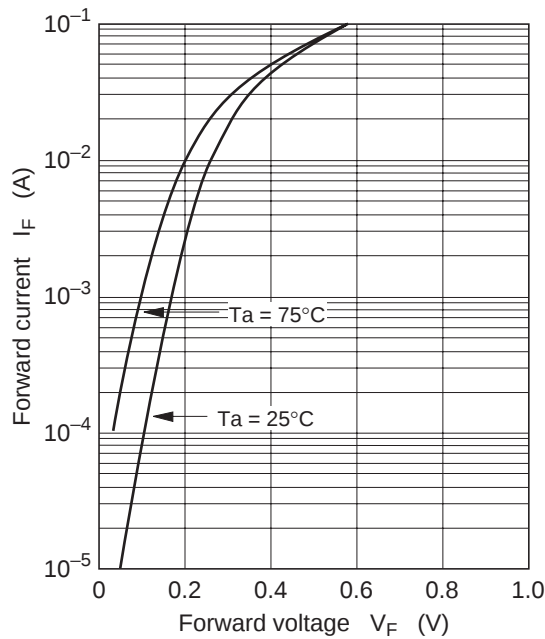


Fig.1 Forward current vs. Forward voltage

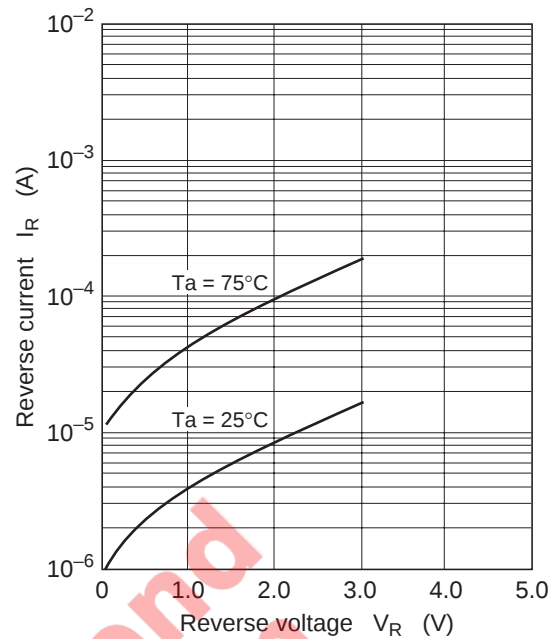


Fig.2 Reverse current vs. Reverse voltage

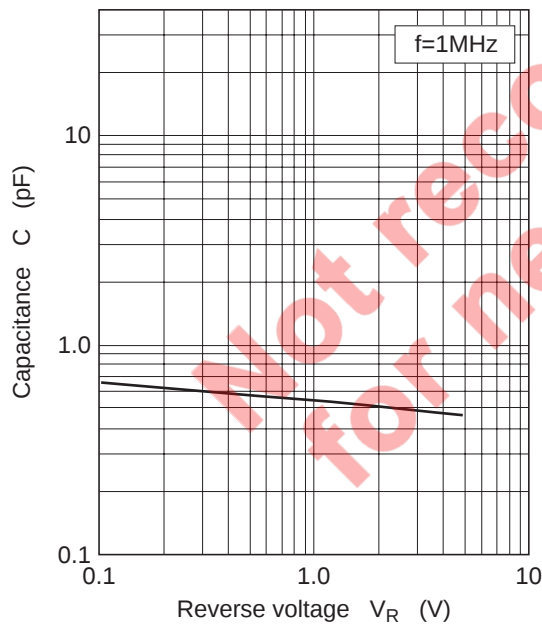
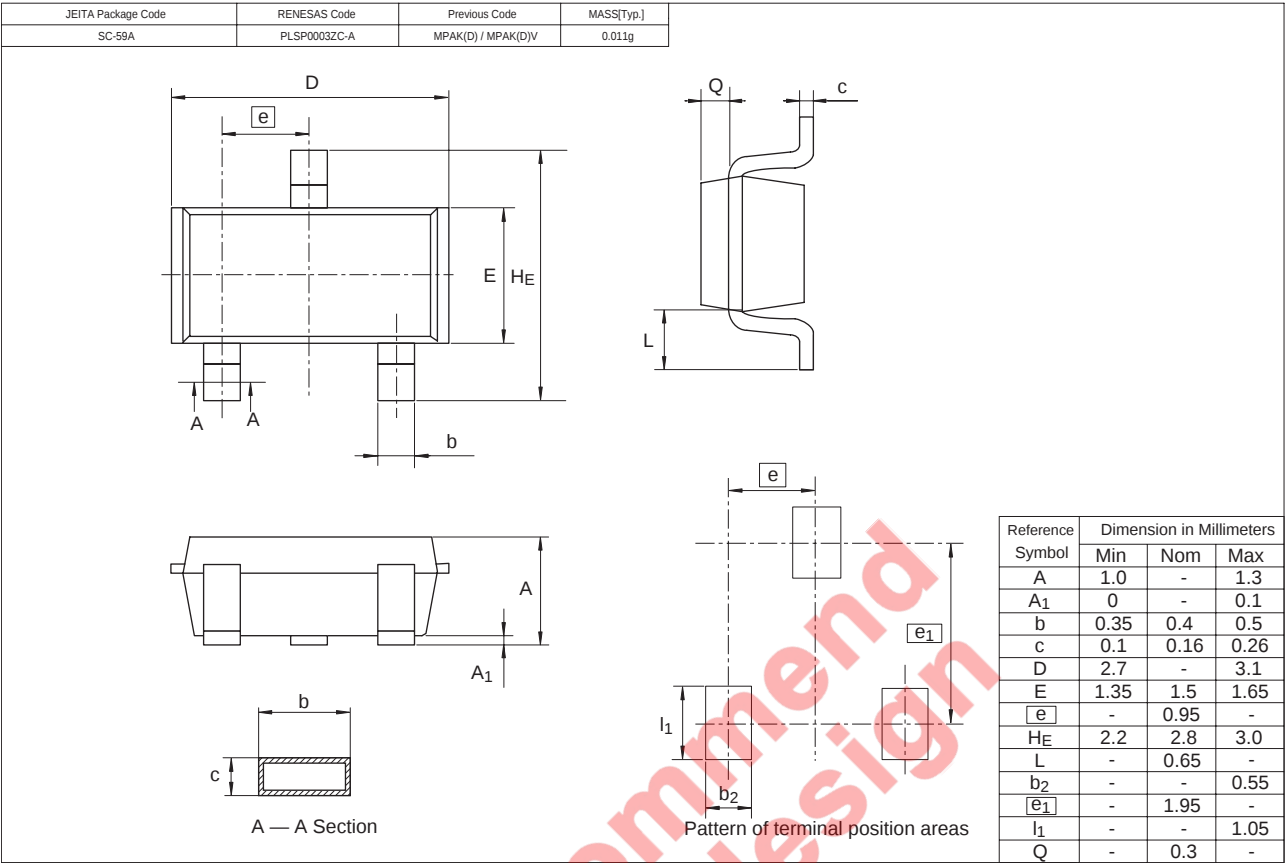


Fig.3 Capacitance vs. Reverse voltage

Package Dimensions



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April 1st, 2010
Renesas Electronics Corporation

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